

# **LOCTITE ABLESTIK ABP 2043**

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#### PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 2043 provides the following product characteristics:

Technology	Ероху
Appearance	Black
Filler Type	Alumina
Product Benefits	Non-conductive
	One component
	Fast cure
	Low temperature cure
	Low stress
	High elongation
	Thermally conductive
Cure	Heat cure
Application	Electronic Material and Component
	assembly
Typical Package	Camera module
Application(s)	
Key Substrates	PCB and Steel

LOCTITE ABLESTIK ABP 2043 non-conductive die attach adhesive is formulated for use in high throughput die attach applications. It is designed to minimize stress and decrease warpage between dissimilar surfaces. When cured, this material has high elongation properties enabling outstanding drop test performance, along with high thermal conductivity for desirable heat dissipation.

### TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):
Speed 5 rpm 14,000
Thixotropic Index (0.5/5 rpm) 4.2
Work Life @ 25°C, days 3
Shelf Life @ -40°C (from date of manufacture), days
Flash Point - See SDS

# TYPICAL CURING PERFORMANCE Recommended Snap Cure Schedule

3 minutes @ 95°C

#### **Alternate Cure Schedule**

Oven cure: 30 minutes @ 80°C

#### Weight Loss on Cure

Weight Loss on Cure, % 0.3

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and specific application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

# TYPICAL PROPERTIES OF CURED MATERIAL

# **Physical Properties**

Coefficient of Thermal Expansion, TMA, ppm/°C:		
Below Tg		50
Above Tg		195
Glass Transition Temperature (Tg) by	TMA, °C	26
DMA Modulus :		
@ 25°C	N/mm²	1,900
	(psi)	(276)

@ 23 0	(psi)	(276)
Thermal Conductivity , W/(m-K)	u ,	0.5
Elongation @ break, %		70
Extractable Ionic Content, :		
Sodium (Na+)		1
Potassium (K+)		1
Chloride (Cl-)		82

# TYPICAL PERFORMANCE OF CURED MATERIAL

### Miscellaneous

Die Shear Strength:

3 x 3 mm Si die on PCB, kg-f:

@ 25°C 12

### Chip Warpage:

 $5 \times 5 \times 6$  mil Si die on 0.3 mm thick PCB,  $\mu$ m 0.5  $9 \times 10 \times 6$  mil Si die on 0.1 mm thick Ni,  $\mu$ m 1

#### **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).



#### **THAWING:**

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.

#### **Directions for Use**

- Thawed material should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- Adhesive must be completely used within the product's recommended work life.
- 4. Alternate dispense amounts may be used depending on the application requirements.
- Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

# **Storage**

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

# Optimal Storage: -40 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Henkel Representative.

#### Conversions

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$ kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb/F N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

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Reference N/A